

Title (en)

HARDWARE PROTECTION SYSTEM IN THE FORM OF DEEP-DRAWN PRINTED CIRCUIT BOARDS AS HALF-SHELLS

Title (de)

HARDWARESCHUTZ IN FORM VON ZU HALBSCHALEN TIEFGEZOGENEN LEITERPLATTEN

Title (fr)

SYSTEME DE PROTECTION PAR MATERIEL SE PRESENTANT SOUS LA FORME DE PLAQUETTES REALISEES EN TANT QUE DEMI-COQUILLES PAR EMBOUTISSAGE PROFOND

Publication

**EP 1897017 A1 20080312 (DE)**

Application

**EP 05756864 A 20050630**

Priority

EP 2005053110 W 20050630

Abstract (en)

[origin: WO2007003227A1] The invention relates to hardware protection system for a circuit, which is to be protected, and which contains a substrate which comprises a recoiling area which is surrounded by protruding areas. Said hardware protection system is embodied, in particular, as half-shells. Said hardware protection system also comprises conductor structures which are arranged on and/or in the substrate in order to detect access to the circuit which is to be protected.

IPC 8 full level

**G06F 21/86** (2013.01)

CPC (source: EP US)

**G06F 21/86** (2013.01 - EP US); **H05K 1/0275** (2013.01 - EP US); **H05K 1/0268** (2013.01 - EP US); **H05K 1/0284** (2013.01 - EP US); **H05K 1/144** (2013.01 - EP US); **H05K 2201/10151** (2013.01 - EP US)

Citation (search report)

See references of WO 2007003227A1

Citation (examination)

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Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU MC NL PL PT RO SE SI SK TR

DOCDB simple family (publication)

**WO 2007003227 A1 20070111**; BR PI0520405 A2 20090505; CN 101248436 A 20080820; CN 101248436 B 20120822; EP 1897017 A1 20080312; JP 2008545259 A 20081211; JP 4740326 B2 20110803; RU 2008103340 A 20090810; RU 2382404 C2 20100220; US 2009109024 A1 20090430

DOCDB simple family (application)

**EP 2005053110 W 20050630**; BR PI0520405 A 20050630; CN 200580051431 A 20050630; EP 05756864 A 20050630; JP 2008518645 A 20050630; RU 2008103340 A 20050630; US 98813105 A 20050630